imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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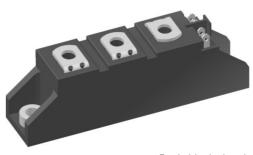
Thyristor Module

MCC56-12io1B

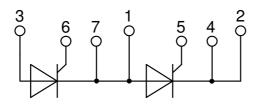
V_{RRM}	<i>=</i> 2x 1200 V		
I _{tav}	=	60 A	
VT	=	1.24 V	

Phase leg

Part number MCC56-12io1B



Backside: isolated **E**72873



Features / Advantages:

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability
- Direct Copper Bonded Al2O3-ceramic

Applications:

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control

Package: TO-240AA

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Terms Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office. Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office. Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

to perform joint risk and quality assessments;
the conclusion of quality agreements;

- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

IXYS reserves the right to change limits, conditions and dimensions.

Data according to IEC 60747and per semiconductor unless otherwise specified

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MCC56-12io1B

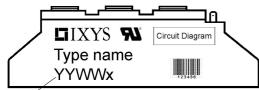
Thyristo Symbol	Definition	Conditions		min.	typ.	max.	Uni
-			T _{vj} = 25°C	min.	typ.	1300	UNI \
V _{RSM/DSM}	max. non-repetitive reverse/forwa max. repetitive reverse/forward b		$T_{vJ} = 25 °C$			1200	، ۱
V _{RRM/DRM}	1	$V_{\rm B/D} = 1200 \text{ V}$	$T_{v_{J}} = 25 \text{ C}$ $T_{v_{J}} = 25^{\circ}\text{C}$				
R/D	reverse current, drain current					200	μ/
.,	for many starting the second starts	V _{R/D} = 1200 V	$T_{\rm VJ} = 125^{\circ}\rm C$			5	m/
V _T	forward voltage drop	$I_{T} = 100 \text{ A}$	$T_{vJ} = 25^{\circ}C$			1.26	۱ ۱
		$I_{T} = 200 \text{ A}$	T 40500			1.57	
		$I_{T} = 100 \text{ A}$	$T_{vJ} = 125 ^{\circ}C$			1.24	
		I _T = 200 A	T 40500			1.62	١
	average forward current	$T_c = 85^{\circ}C$	$T_{VJ} = 125^{\circ}C$			60	A
T(RMS)	RMS forward current	180° sine				94	A
V _{T0}	threshold voltage } for power l	oss calculation only	$T_{vJ} = 125^{\circ}C$			0.85	١
r _T	slope resistance					3.7	mΩ
R _{thJC}	thermal resistance junction to cas	5e				0.45	K/W
R _{thCH}	thermal resistance case to heats	ink			0.20		K/W
P _{tot}	total power dissipation		$T_c = 25^{\circ}C$			222	W
I _{TSM}	max. forward surge current	t = 10 ms; (50 Hz), sine	$T_{vJ} = 45^{\circ}C$			1.50	kA
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			1.62	kA
		t = 10 ms; (50 Hz), sine	T _{vJ} = 125°C			1.28	kA
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			1.38	kA
l²t	value for fusing	t = 10 ms; (50 Hz), sine	$T_{vJ} = 45^{\circ}C$			11.3	kA ² s
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			10.9	1
		t = 10 ms; (50 Hz), sine	T _{v.i} = 125°C			8.13	kA ² s
		t = 8,3 ms; (60 Hz), sine	$V_{R} = 0 V$			7.87	
C	junction capacitance	$V_{\rm B} = 400 \mathrm{V}$ f = 1 MHz	$T_{VJ} = 25^{\circ}C$		74		pF
P _{GM}	max. gate power dissipation	$t_{\rm P}$ = 30 µs	T _c = 125°C			10	W
- GW	max. gate perior acceptation	$t_{\rm P} = 300 \mu {\rm s}$				5	W
P _{GAV}	average gate power dissipation					0.5	W
(di/dt) _{cr}	critical rate of rise of current	T _{v.l} = 125 °C; f = 50 Hz re	epetitive, $I_{T} = 150 \text{ A}$			150	
(ul/ut) _{cr}		$t_{P} = 200 \mu s; di_{G}/dt = 0.45 \text{A}/\mu s; -$	•			150	πμ
			on-repet., $I_{\tau} = 60 \text{ A}$			500	۸/۱۰
(a). (a).	aritical rate of rise of valtage						Α/με
(dv/dt) _{cr}	critical rate of rise of voltage	$V = \frac{2}{3} V_{DRM}$	$T_{vJ} = 125^{\circ}C$			1000	ν/με
		$R_{GK} = \infty$; method 1 (linear volta					
V _{GT}	gate trigger voltage	$V_{D} = 6 V$	$T_{VJ} = 25^{\circ}C$			1.5	۷ ۱
_			$T_{VJ} = -40^{\circ}C$			1.6	۷
I _{GT}	gate trigger current	$V_{D} = 6 V$	$T_{vJ} = 25^{\circ}C$			100	mA
			$T_{vJ} = -40 ^{\circ}\text{C}$			200	mA
V _{gd}	gate non-trigger voltage	$V_{D} = \frac{2}{3} V_{DRM}$	$T_{vJ} = 125^{\circ}C$			0.2	۷
I _{GD}	gate non-trigger current					10	mA
I.	latching current	t _p = 10 μs	$T_{vJ} = 25 \degree C$			450	mA
		$I_{G} = 0.45 \text{ A}; \ di_{G}/dt = 0.45 \text{ A}/\mu s$	3				
I _H	holding current	$V_{D} = 6 V R_{GK} = \infty$	$T_{vJ} = 25 °C$			200	mA
t _{gd}	gate controlled delay time	$V_{D} = \frac{1}{2} V_{DRM}$	$T_{vJ} = 25 \degree C$			2	με
		$I_{G} = 0.45 \text{ A}; \ di_{G}/dt = 0.45 \text{ A}/\mu s$	3				1
t _q	turn-off time	$V_{\rm B} = 100 \text{ V}; \ I_{\rm T} = 150 \text{ A}; \ V = \frac{2}{3}$			150		με
		$di/dt = 10 \text{ A}/\mu \text{s} dv/dt = 20 \text{ V}$					•

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MCC56-12io1B

Package	TO-240AA				F	Rating	S	
Symbol	Definition	Conditions			min.	typ.	max.	Unit
	RMS current	per terminal					200	Α
T _{vj}	virtual junction temperature				-40		125	°C
T _{op}	operation temperature				-40		100	°C
T _{stg}	storage temperature				-40		125	°C
Weight						81		g
M _D	mounting torque		2.5		4	Nm		
M _T	terminal torque				2.5		4	Nm
d _{Spp/App}	creepage distance on surface striking distance through air		terminal to terminal	13.0	9.7			mm
d _{Spb/Apb}	creepage uistance on surract	e Striking distance through an	terminal to backside	16.0	16.0			mm
V	isolation voltage	t = 1 second			3600			V
		t = 1 minute	50/60 Hz, RMS; liso∟ ≤ 1 mA		3000			v



Date Code

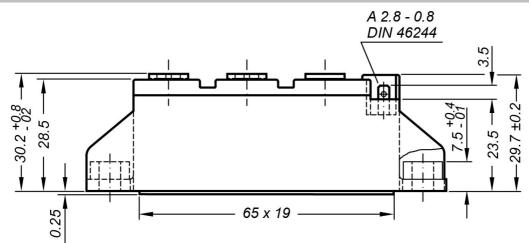
Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MCC56-12io1B	MCC56-12io1B	Box	36	452742

Similar Part	Package	Voltage class
MCMA65P1200TA	TO-240AA-1B	1200
MCMA85P1200TA	TO-240AA-1B	1200

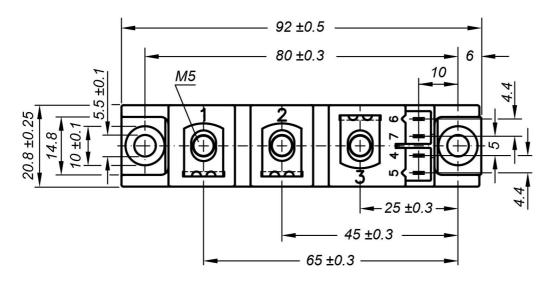
Equiva	lent Circuits for	Simulation	* on die level	T _{vj} = 125 °C
	⊢R₀_⊢	Thyristor		
V _{0 max}	threshold voltage	0.85		V
$\mathbf{R}_{0 \max}$	slope resistance *	2.5		mΩ

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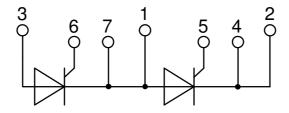
Outlines TO-240AA



General tolerance: DIN ISO 2768 class "c"

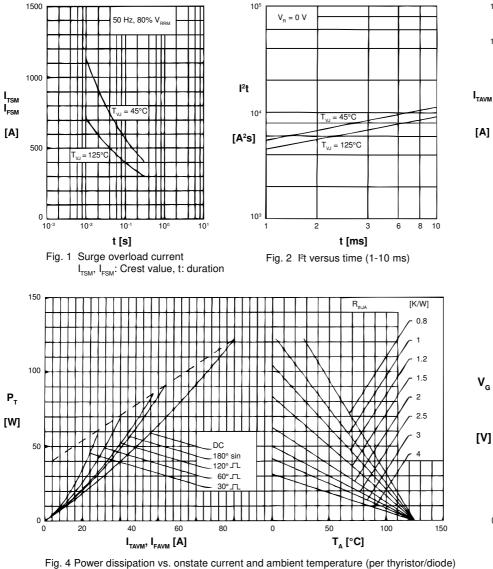


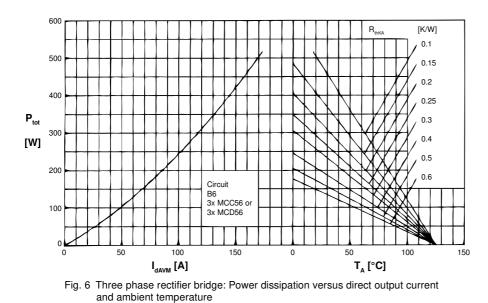
Optional accessories: Keyed gate/cathode twin plugs Wire length: 350 mm, gate = white, cathode = red UL 758, style 3751 Type **ZY 200L** (L = Left for pin pair 4/5) Type **ZY 200R** (R = Right for pin pair 6/7)



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Thyristor





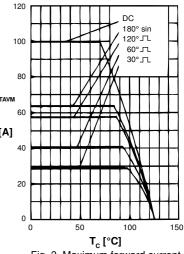


Fig. 3 Maximum forward current at case temperature

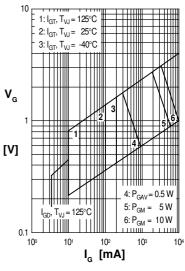


Fig. 5 Gate trigger charact.

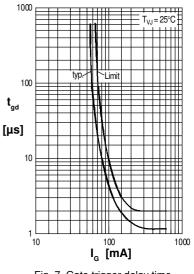
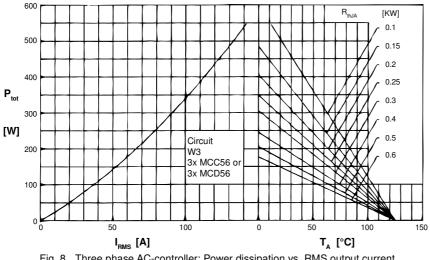


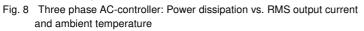
Fig. 7 Gate trigger delay time

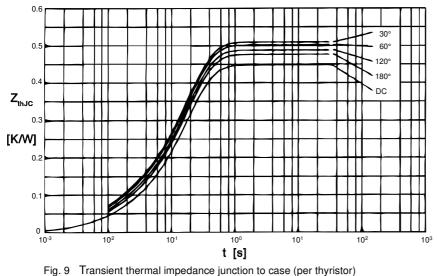


MCC56-12io1B

Thyristor



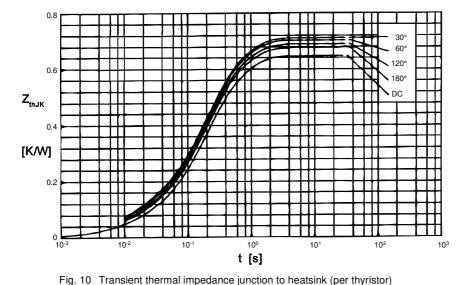




R_{thJC} for various conduction angles d:					
	d R _t	_{hJC} [K/W]			
	DC	0.450			
	180°	0.470			
	120°	0.490			
	60°	0.505			
	30°	0.520			
Constants for Z_{thJC} calculation:					
i F	R _{thi} [K/W	/] t _i [s]			
1	0.014	0.0150			
2	0.026	0.0095			

3	0.410	0.1750





$R_{th,IK}$ for various conduction angles d:				
d	R _{thJK} [K/W]			
DC	0.650			
180°	0.670			
120°	0.690			
60°	0.705			
30°	0.720			
Constants for Z _{th.IK} calculation:				

•••		-thJK
i	R _{thi} [K/W]	t _i [s]
1	0.014	0.0150
2	0.026	0.0095
3	0.410	0.1750
4	0.200	0.6700

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